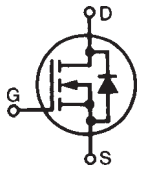
IXYS

TrenchMV™ Power MOSFET

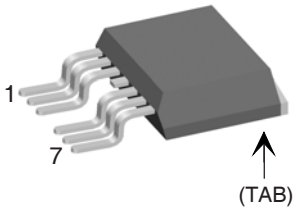
IXTA180N085T7

V_{DSS} = 85V
I_{D25} = 180A
$R_{DS(on)}$ ≤ 5.5mΩ

N-Channel Enhancement Mode
Avalanche Rated
Fast Intrinsic Rectifier



TO-263 (7-lead)



Pins: 1 - Gate
2, 3 - Source
5,6,7 - Source
TAB (8) - Drain

Symbol	Test Conditions	Maximum Ratings	
V_{DSS}	T_J = 25°C to 175°C	85	V
V_{DGR}	T_J = 25°C to 175°C, R_{GS} = 1MΩ	85	V
V_{GSM}	Transient	± 20	V
I_{D25}	T_C = 25°C	180	A
I_{LRMS}	Lead Current Limit, RMS	160	A
I_{DM}	T_C = 25°C, Pulse Width Limited by T_{JM}	480	A
I_A	T_C = 25°C	25	A
E_{AS}	T_C = 25°C	1.0	J
P_D	T_C = 25°C	430	W
T_J		-55 ... +175	°C
T_{JM}		175	°C
T_{stg}		-55 ... +175	°C
T_L	1.6mm (0.062in.) from Case for 10s	300	°C
T_{sold}	Plastic Body for 10 seconds	260	°C
Weight		3	g

Symbol	Test Conditions (T_J = 25°C Unless Otherwise Specified)	Characteristic Values Min.	Typ.	Max.	
BV_{DSS}	V_{GS} = 0V, I_D = 250μA	85			V
$V_{GS(th)}$	$V_{DS} = V_{GS}$, I_D = 250μA	2.0		4.0	V
I_{GSS}	V_{GS} = ± 20V, V_{DS} = 0V			±200	nA
I_{DSS}	$V_{DS} = V_{DSS}$, V_{GS}= 0V			5	μA
	T_J = 150°C			250	μA
$R_{DS(on)}$	V_{GS} = 10V, I_D = 25A, Notes 1, 2		4.5	5.5	mΩ

Features

- International Standard Package
- 175°C Operating Temperature
- Avalanche Rated
- Fast Intrinsic Rectifier
- Low $R_{DS(on)}$

Advantages

- Easy to Mount
- Space Savings
- High Power Density

Applications

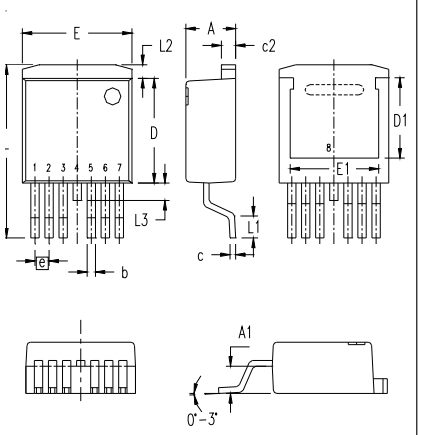
- Automotive
  - Motor Drives
  - DC/DC Conversion
  - 42V Power Bus
  - ABS Systems
- DC/DC Converters and Off-Line UPS
- Primary Switch for 24V and 48V Systems
- High Current Switching Applications
- Distributed Power Architechtures and VRMs
- Electronic Valve Train Systems
- High Voltage Synchronous Recifiers

Symbol	Test Conditions (T_J = 25°C, Unless Otherwise Specified)	Characteristic Values Min.	Typ.	Max.	
g_{fs}	V_{DS} = 10V, I_D = 60A, Note 1	70	120		S
C_{iss}	V_{GS} = 0V, V_{DS} = 25V, f = 1MHz		8800		pF
C_{oss}			950		pF
C_{rss}			110		pF
$t_{d(on)}$	**Resistive Switching Times**		32		ns
t_r	V_{GS} = 10V, V_{DS} = 0.5 • V_{DSS}, I_D = 25A		70		ns
$t_{d(off)}$	R_G = 5Ω (External)		55		ns
t_f			65		ns
$Q_{g(on)}$	V_{GS} = 10V, V_{DS} = 0.5 • V_{DSS}, I_D = 25A		170		nC
Q_{gs}			40		nC
Q_{gd}			46		nC
R_{thJC}				0.35	°C/W

Source-Drain Diode

Symbol	Test Conditions (T_J = 25°C, Unless Otherwise Specified)	Characteristic Values Min.	Typ.	Max.	
I_S	V_{GS} = 0V			180	A
I_{SM}	Repetitive, Pulse Width Limited by T_{JM}			480	A
V_{SD}	I_F = 25A, V_{GS} = 0V, Note 1			1.0	V
t_{rr}	I_F = 90A, V_{GS} = 0V, -di/dt = 100A/μs		63		ns
I_{RM}	V_R = 40V		4.1		A
Q_{RM}			129		nC

TO-263 (7-lead) (IXTA..7) Outline



Pins: 1 - Gate
2, 3 - Source
4 - Drain
5,6,7 - Source
Tab (8) - Drain

SYM	INCHES MIN	INCHES MAX	MILLIMETER MIN	MILLIMETER MAX
A	.170	.185	4.30	4.70
A1	.085	.104	2.15	2.65
b	.026	.035	0.65	0.90
c	.016	.024	0.40	0.60
c2	.049	.055	1.25	1.40
D	.355	.370	9.00	9.40
D1	.272	.280	6.90	7.10
E	.386	.402	9.80	10.20
E1	.311	.319	7.90	8.10
e	.050 BSC		1.27 BSC	
L	.591	.614	15.00	15.60
L1	.091	.110	2.30	2.80
L2	.039	.059	1.00	1.50
L3	.000	.059	0.00	1.50

Notes: 1. Pulse Test, t ≤ 300μs; Duty Cycle, d ≤ 2%.
2. On Through-Hole Packages, $R_{DS(on)}$ Kelvin Test Contact Location must be 5mm or Less from the Package Body.

Fig. 1. Output Characteristics @ 25ºC

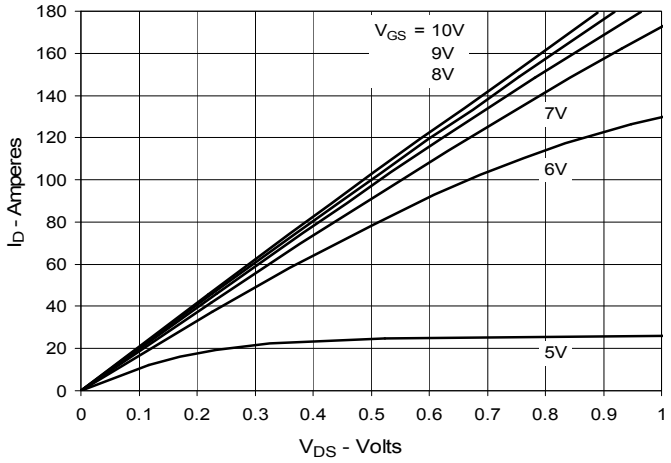


Fig. 2. Extended Output Characteristics @ 25ºC

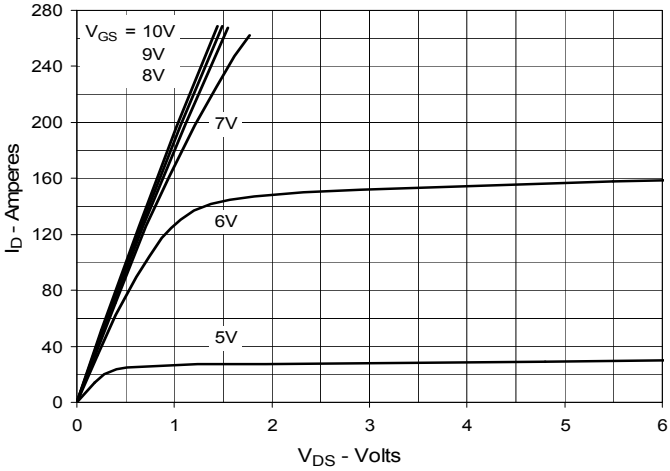


Fig. 3. Output Characteristics @ 150ºC

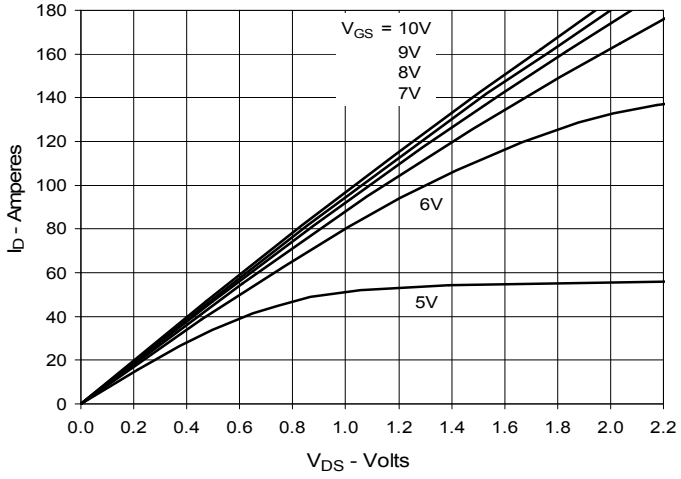


Fig. 4. $R_{DS(on)}$ Normalized to I_D = 90A Value vs. Junction Temperature

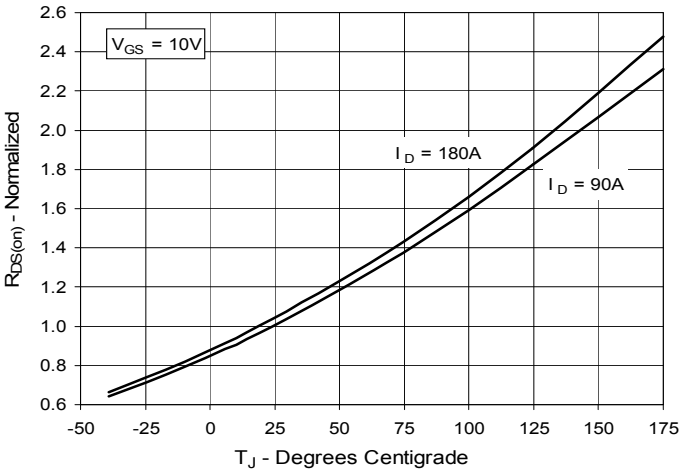


Fig. 5. $R_{DS(on)}$ Normalized to I_D = 90A Value vs. Drain Current

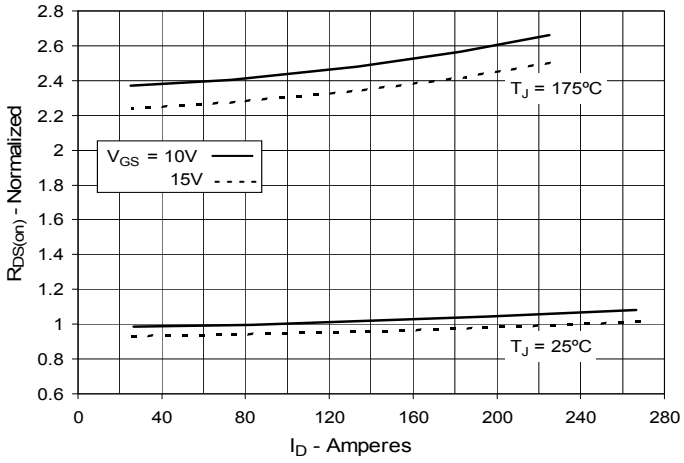


Fig. 6. Drain Current vs. Case Temperature

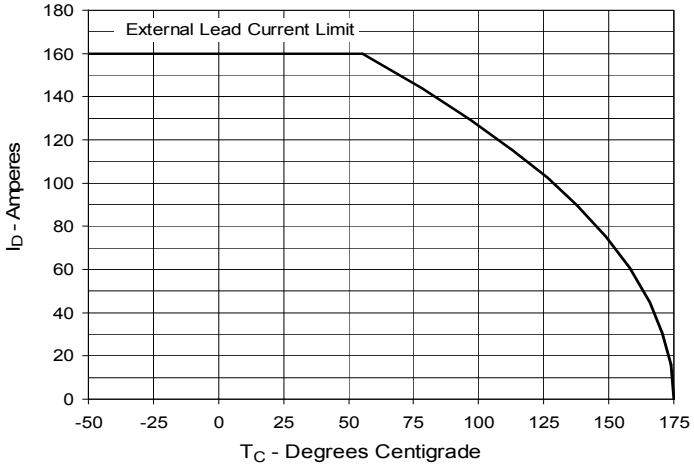


Fig. 7. Input Admittance

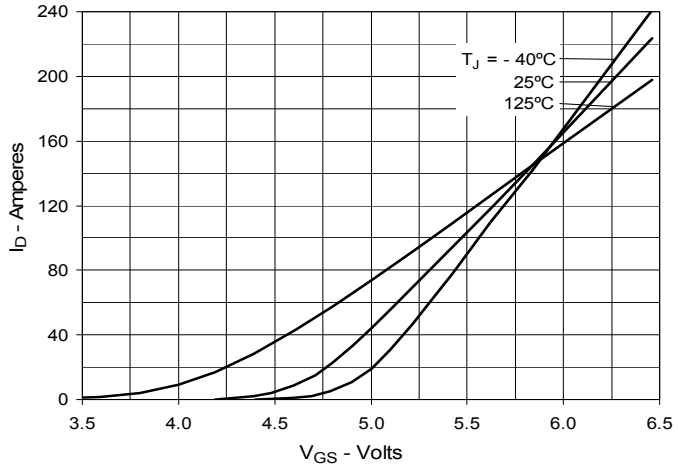


Fig. 8. Transconductance

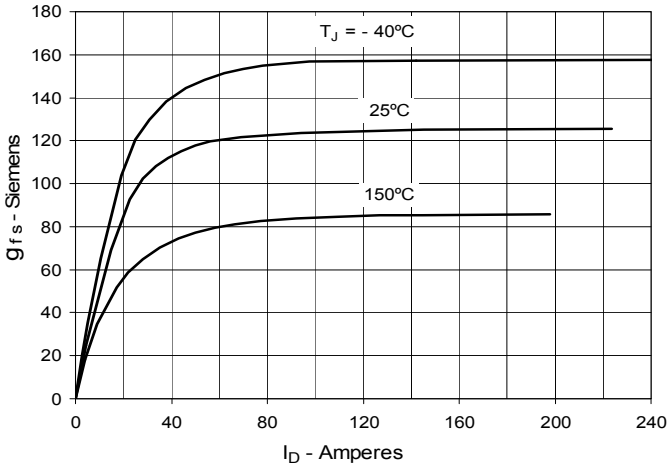


Fig. 9. Forward Voltage Drop of Intrinsic Diode

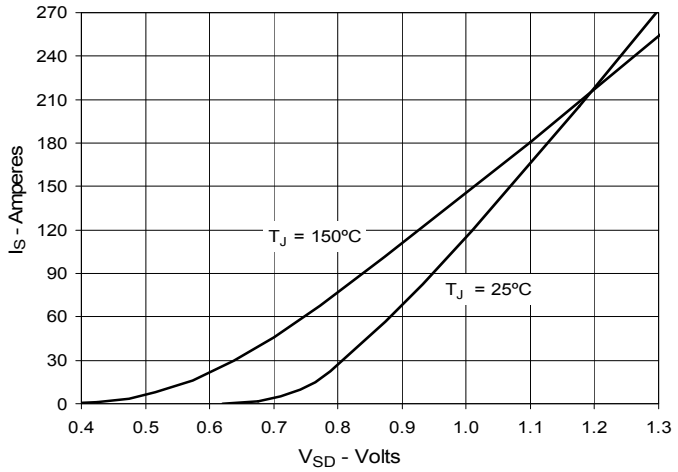


Fig. 10. Gate Charge

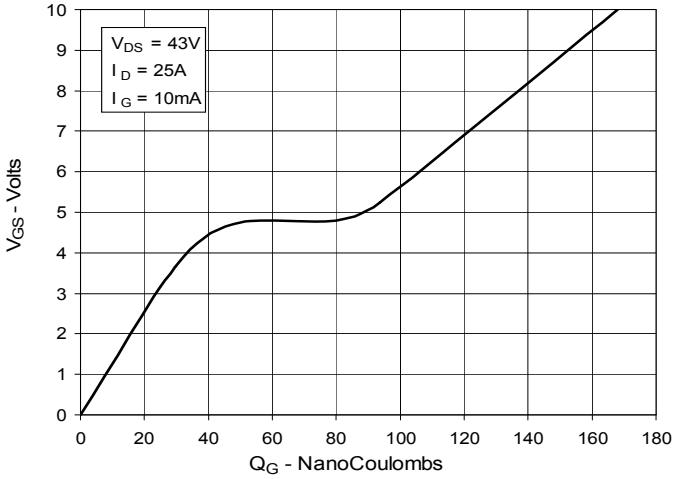


Fig. 11. Capacitance

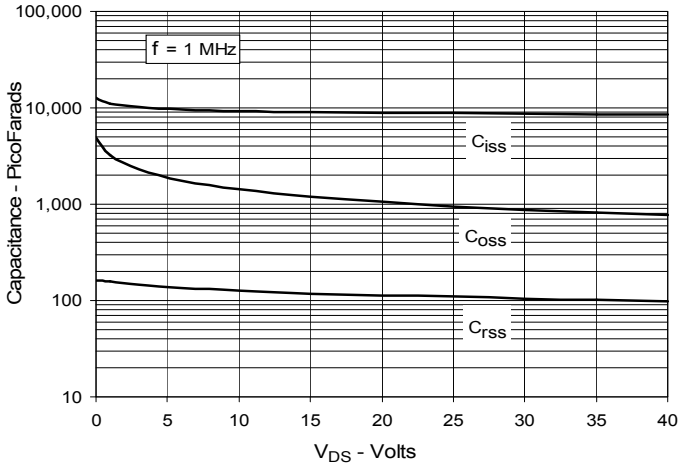


Fig. 12. Maximum Transient Thermal Impedance

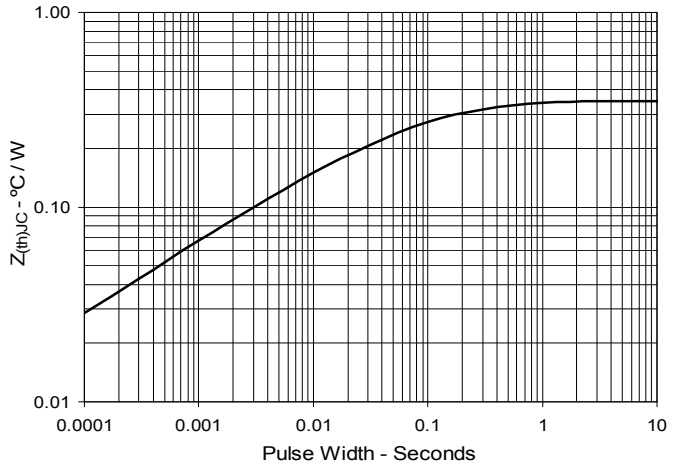


Fig. 13. Resistive Turn-on Rise Time vs. Junction Temperature

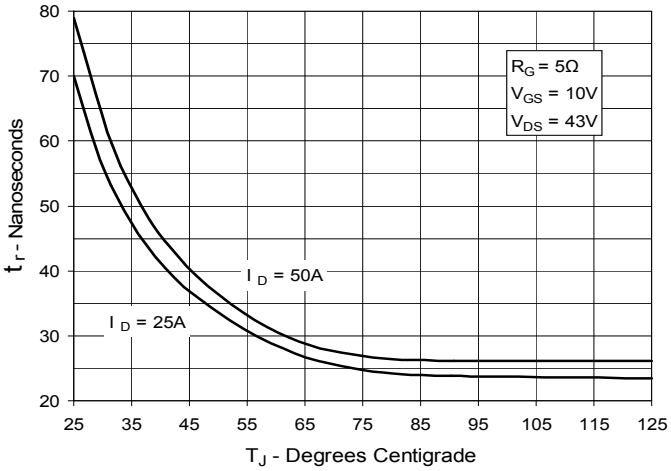


Fig. 14. Resistive Turn-on Rise Time vs. Drain Current

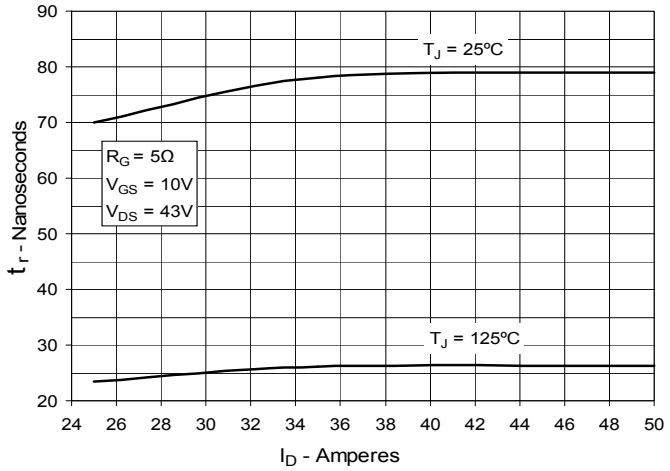


Fig. 15. Resistive Turn-on Switching Times vs. Gate Resistance

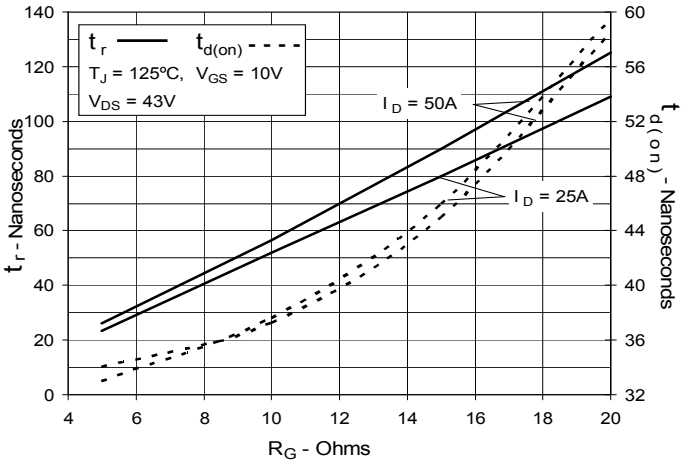


Fig. 16. Resistive Turn-off Switching Times vs. Junction Temperature

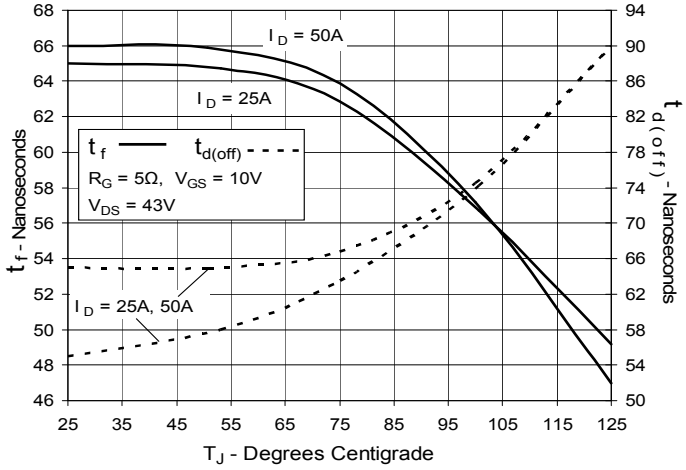


Fig. 17. Resistive Turn-off Switching Times vs. Drain Current

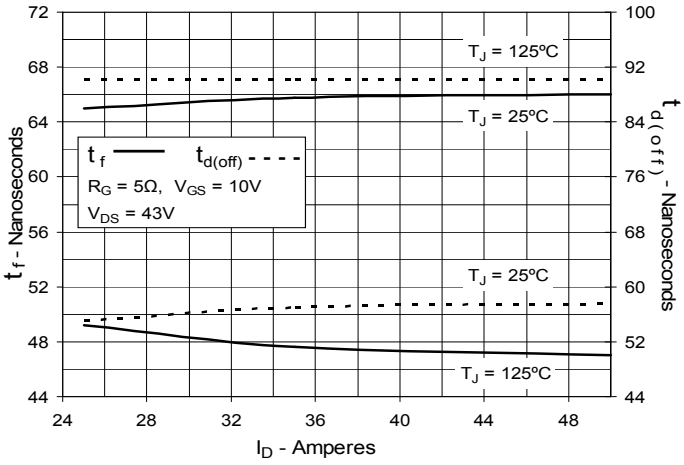


Fig. 18. Resistive Turn-off Switching Times vs. Gate Resistance